

S-Bond Technologies LLC

811 W. Fifth Street, Lansdale, PA 19446, USA • www.S-Bond.com
Tel: (215) 631-7114 / FAX: (215) 631-7115 • Email: info@s-bond.com

FOR IMMEDIATE RELEASE **M Cubed Technologies, Inc. and S-Bond Technologies, LLC Announce Exclusive License Agreement**

May 26, 2016.....M Cubed Technologies, Inc. (MCubed) and Division of II-VI Incorporated, and S-Bond Technologies, LLC (S-Bond) announced today that MCubed has acquired an exclusive license to S-Bond's Active Soldering Process for Lithography applications. S-Bond and MCubed will maintain a close ongoing relationship while transferring this technology, and will continue to work together to advance the technology as it relates to the active soldering of metal and ceramic components designed to meet the demands of the semiconductor lithography process.

In regards to the transaction, Paul Heller, General Manager of M Cubed's Precision Products Division noted, "we are looking forward to continuing the long successful relationship with S-Bond during the transfer of this technology to M Cubed. While MCubed has obtained exclusive rights to the technology noted, there are many other opportunities for collaboration, including thermal management and optics, and our companies will continue to develop technologies to address applications in these areas.

Ron Smith, President of S-Bond Technologies added "this agreement strengthens the use of active solders in critical applications and demonstrates the utility of this technology. We look forward to our relationship with M Cubed and we look ahead to working together to develop additional bonding solutions in a broader set of applications of mutual interest."

About M Cubed Technologies, Inc.

M Cubed Technologies, Inc. develops and manufactures reaction bonded ceramic and metal matrix composite products for the semiconductor, display, industrial and defense markets.

About II-VI Incorporated

[II-VI Incorporated](#), a global leader in engineered materials and opto-electronic components, is a vertically-integrated manufacturing company that creates and markets products for diversified markets including industrial manufacturing, optical communications, military and aerospace, high-power electronics, semiconductor laser and thermoelectronics applications. Headquartered in Saxonburg, Pennsylvania, with manufacturing, sales and distribution facilities worldwide, the Company produces numerous crystalline compounds including zinc selenide for infrared laser optics, silicon carbide for high-power electronic and microwave applications, and bismuth telluride for thermoelectric coolers.

About S-Bond Technologies, LLC.

[S-Bond Technologies](#) is materials bonding solutions company offering technologies and services for the joining of dissimilar materials, ceramic to metals and aluminum. S-Bond Technologies creates and supports assembly solutions for applications across many markets, including electronics, defense, aerospace, and general industrial markets.

Media Contact

Craig Emmons
M Cubed Technologies, Inc.
203 452 2515
cemmons@mmt.com

Name Ronald Smith
S-Bond Technologies, LLC
215-631-7114
info@s-bond.com